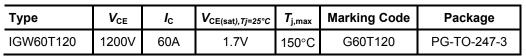


## Low Loss IGBT in TrenchStop® and Fieldstop technology

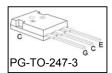
- Best in class TO247
- Short circuit withstand time 10 µs
- Designed for:
  - Frequency Converters
  - Uninterrupted Power Supply
- TrenchStop® and Fieldstop technology for 1200 V applications offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
- NPT technology offers easy parallel switching capability due to positive temperature coefficient in V<sub>CE(sat)</sub>
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/



### **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CE</sub>	1200	V
DC collector current	I <sub>C</sub>		Α
$T_{\rm C}$ = 25°C		100	
$T_{\rm C}$ = 90°C		60	
Pulsed collector current, $t_p$ limited by $T_{jmax}$	I <sub>Cpuls</sub>	150	
Turn off safe operating area	-	150	
$V_{CE} \le 1200 \text{V}, \ T_{j} \le 150 ^{\circ} \text{C}$			
Gate-emitter voltage	$V_{GE}$	±20	V
Short circuit withstand time <sup>2)</sup>	tsc	10	μS
$V_{\rm GE}$ = 15V, $V_{\rm CC} \le$ 1200V, $T_{\rm j} \le$ 150°C			
Power dissipation	P <sub>tot</sub>	375	W
$T_{\rm C}$ = 25°C			
Operating junction temperature	T <sub>j</sub>	-40+150	°C
Storage temperature	$T_{\rm stg}$	-55+150	
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	





<sup>&</sup>lt;sup>1</sup> J-STD-020 and JESD-022 <sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.



#### **Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	$R_{thJC}$		0.33	K/W
junction – case				
Thermal resistance,	$R_{thJA}$		40	
junction – ambient				

### **Electrical Characteristic,** at $T_j$ = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			I I m i 4
			min.	typ.	max.	Unit
Static Characteristic	•	•	•	•	•	
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}$ =0V, $I_{C}$ =3.0mA	1200	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{\rm GE} = 15  \rm V, I_{\rm C} = 60  \rm A$				
		<i>T</i> <sub>j</sub> =25°C	-	1.9	2.4	
		T <sub>j</sub> =125°C	-	2.1	-	
		T <sub>j</sub> =150°C	-	2.3	-	
Gate-emitter threshold voltage	$V_{\rm GE(th)}$	$I_{\rm C}$ =2.0mA, $V_{\rm CE}$ = $V_{\rm GE}$	5.0	5.8	6.5	
Zero gate voltage collector current	I <sub>CES</sub>	V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V				mA
		<i>T</i> <sub>j</sub> =25°C	-	-	0.6	
		T <sub>j</sub> =150°C	-	-	6.0	
Gate-emitter leakage current	I <sub>GES</sub>	V <sub>CE</sub> =0V, V <sub>GE</sub> =20V	-	-	600	nA
Transconductance	$g_{fs}$	V <sub>CE</sub> =20V, I <sub>C</sub> =60A	-	30	-	S
Integrated gate resistor	R <sub>Gint</sub>			4		Ω

### **Dynamic Characteristic**

Input capacitance	Ciss	V <sub>CE</sub> =25V,	-	3700	-	pF
Output capacitance	Coss	V <sub>GE</sub> =0V,	-	180	-	
Reverse transfer capacitance	Crss	f=1MHz	1	150	1	
Gate charge	Q <sub>Gate</sub>	$V_{\rm CC}$ =960V, $I_{\rm C}$ =60A	-	280	-	nC
		V <sub>GE</sub> =15V				
Internal emitter inductance	LE		-	13	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current <sup>1)</sup>	I <sub>C(SC)</sub>	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 10 \mu\text{s}$ $V_{\text{CC}} = 600 \text{V},$ $T_{\text{j}} = 25 ^{\circ}\text{C}$	1	300	1	A

2

<sup>&</sup>lt;sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.



### Switching Characteristic, Inductive Load, at $T_i$ =25 °C

Parameter	Cymahal	Conditions	Value			I I mit
	Symbol		min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t <sub>d(on)</sub>	<i>T</i> <sub>j</sub> =25°C,	-	50	-	ns
Rise time	t <sub>r</sub>	$V_{CC}$ =600V, $I_{C}$ =60A, $V_{GE}$ =0/15V, $R_{G}$ =10 $\Omega$ , $L_{\sigma}^{2)}$ =180nH, $C_{\sigma}^{2)}$ =39pF Energy losses include "tail" and diode reverse recovery.	-	44	-	
Turn-off delay time	t <sub>d(off)</sub>		-	480	-	
Fall time	t <sub>f</sub>		-	80	-	
Turn-on energy	Eon		-	4.3	-	mJ
Turn-off energy	E <sub>off</sub>		-	5.2	-	
Total switching energy	Ets		-	9.5	-	

### Switching Characteristic, Inductive Load, at $T_j$ =150 °C

Parameter	Symbol	Conditions	Value			I I mid
	Symbol		min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	T <sub>j</sub> =150°C	-	50	-	ns
Rise time	$t_{r}$	$V_{CC}=600V, I_{C}=60A, V_{GE}=0/15V, R_{G}=10\Omega, L_{\sigma}^{2)}=180nH,$	-	45	-	
Turn-off delay time	$t_{d(off)}$		-	600	-	
Fall time	$t_{f}$		-	130	-	
Turn-on energy	Eon	$C_{\sigma}^{2)}$ =39pF Energy losses include	-	6.4	-	mJ
Turn-off energy	E <sub>off</sub>	"tail" and diode reverse recovery.	-	9.4	-	
Total switching energy	E <sub>ts</sub>		-	15.8	-	

 $<sup>^{2)}</sup>$  Leakage inductance L  $_{\sigma}$  and  $\,$  Stray capacity C  $_{\sigma}$  due to dynamic test circuit in Figure E.





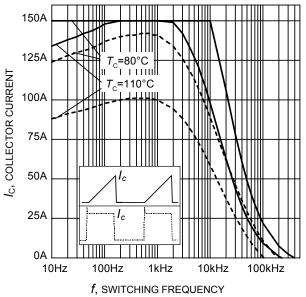


Figure 1. Collector current as a function of switching frequency  $(T_{\rm j} \le 150^{\circ}{\rm C}, \, D=0.5, \, V_{\rm CE}=600{\rm V}, \, V_{\rm GE}=0/+15{\rm V}, \, R_{\rm G}=10\Omega)$ 

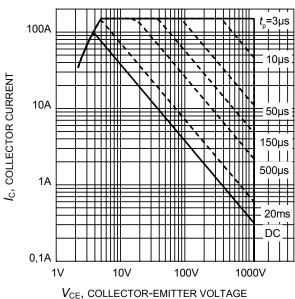


Figure 2. Safe operating area  $(D = 0, T_C = 25^{\circ}\text{C}, T_i \le 150^{\circ}\text{C}; V_{GE} = 15\text{V})$ 

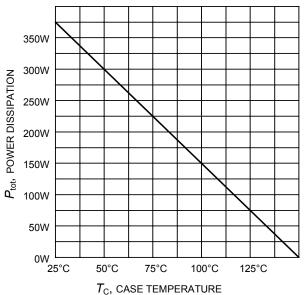


Figure 3. Power dissipation as a function of case temperature  $(T_i \le 150^{\circ}\text{C})$ 

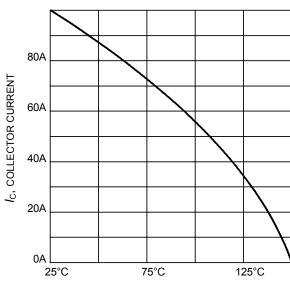


Figure 4. Collector current as a function of case temperature  $(V_{GE} \ge 15V, T_i \le 150^{\circ}C)$ 

 $T_{\rm C}$ , case temperature



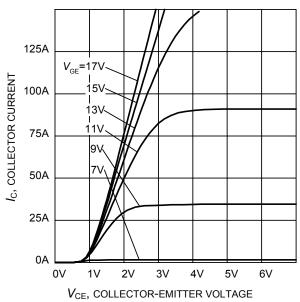


Figure 5. Typical output characteristic  $(T_i = 25^{\circ}C)$ 

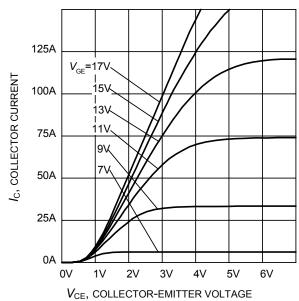


Figure 6. Typical output characteristic  $(T_i = 150^{\circ}\text{C})$ 

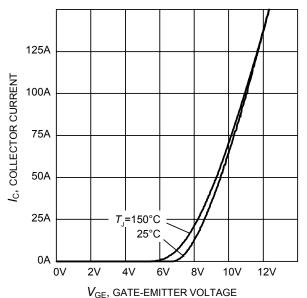


Figure 7. Typical transfer characteristic  $(V_{CE}=20V)$ 

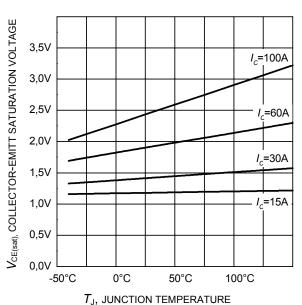


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature  $(V_{GE} = 15V)$ 

5



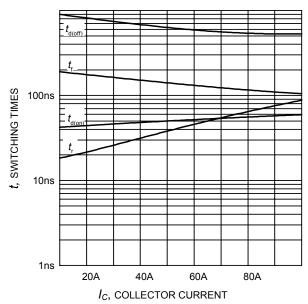


Figure 9. Typical switching times as a function of collector current (inductive load,  $T_J$ =150°C,  $V_{CE}$ =600V,  $V_{GE}$ =0/15V,  $R_G$ =10 $\Omega$ , Dynamic test circuit in Figure E)

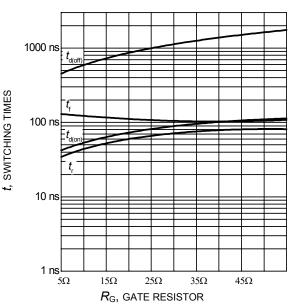


Figure 10. Typical switching times as a function of gate resistor (inductive load,  $T_J$ =150°C,  $V_{CE}$ =600V,  $V_{GE}$ =0/15V,  $I_C$ =60A, Dynamic test circuit in Figure E)

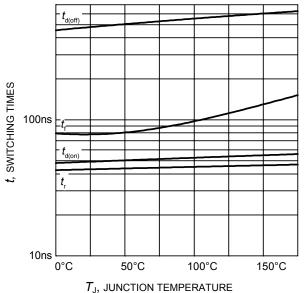


Figure 11. Typical switching times as a function of junction temperature (inductive load,  $V_{\text{CE}}$ =600V,  $V_{\text{GE}}$ =0/15V,  $I_{\text{C}}$ =60A,  $R_{\text{G}}$ =10 $\Omega$ , Dynamic test circuit in Figure E)

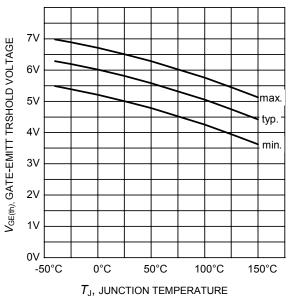


Figure 12. Gate-emitter threshold voltage as a function of junction temperature  $(I_C = 2.0 \text{mA})$ 



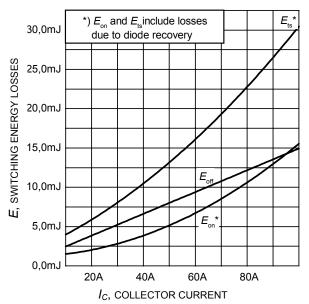


Figure 13. Typical switching energy losses as a function of collector current (inductive load,  $T_J$ =150°C,  $V_{CE}$ =600V,  $V_{GE}$ =0/15V,  $R_G$ =10 $\Omega$ , Dynamic test circuit in Figure E)

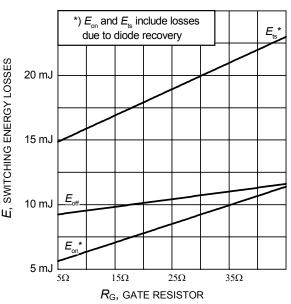


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load,  $T_J$ =150°C,  $V_{CE}$ =600V,  $V_{GE}$ =0/15V,  $I_C$ =60A, Dynamic test circuit in Figure E)

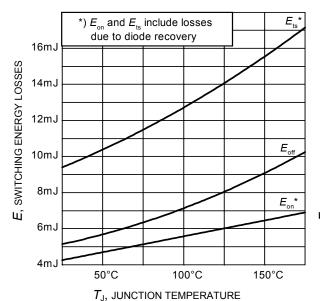
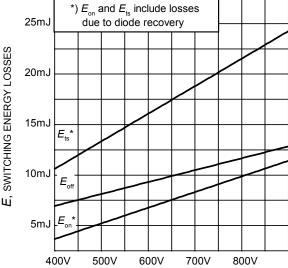


Figure 15. Typical switching energy losses as a function of junction temperature

(inductive load,  $V_{\rm CE}$ =600V,  $V_{\rm GE}$ =0/15V,  $I_{\rm C}$ =60A,  $R_{\rm G}$ =10 $\Omega$ , Dynamic test circuit in Figure E)



 $V_{\it CE}$ , COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load,  $T_{\rm J}$ =150°C,  $V_{\rm GE}$ =0/15V,  $I_{\rm C}$ =60A,  $R_{\rm G}$ =10 $\Omega$ , Dynamic test circuit in Figure E)



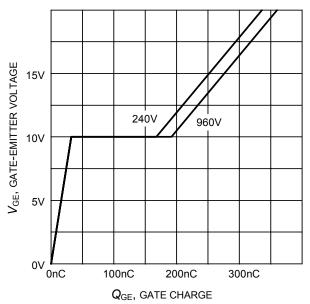
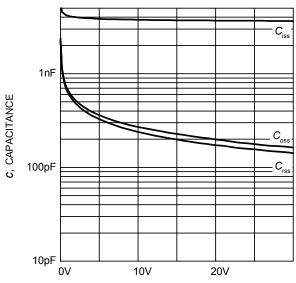


Figure 17. Typical gate charge  $(I_C=60 \text{ A})$ 



 $V_{\text{CE}}$ , COLLECTOR-EMITTER VOLTAGE

Figure 18. Typical capacitance as a function of collector-emitter voltage  $(V_{GE}=0V, f=1 \text{ MHz})$ 

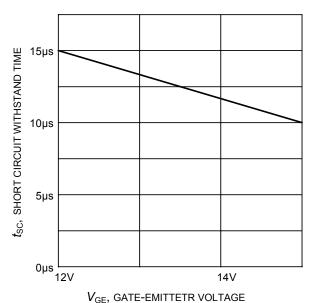
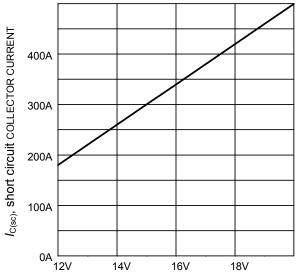


Figure 19. Short circuit withstand time as a function of gate-emitter voltage ( $V_{CE}$ =600V, start at  $T_J$ =25°C)



 $V_{\rm GE}$ , GATE-EMITTETR VOLTAGE Figure 20. Typical short circuit collector current as a function of gate-emitter voltage

 $(V_{CE} \le 600 \text{V}, T_{j} \le 150 ^{\circ}\text{C})$ 



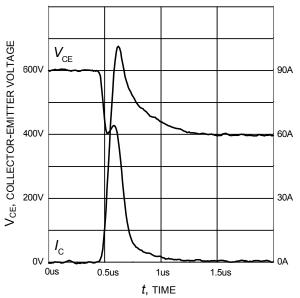


Figure 21. Typical turn on behavior  $(V_{GE}=0/15V, R_{G}=10\Omega, T_{j}=150^{\circ}C, Dynamic test circuit in Figure E)$ 

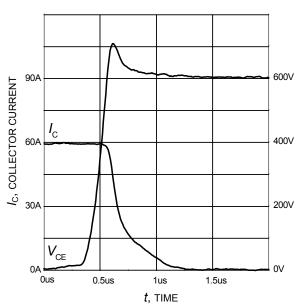


Figure 22. Typical turn off behavior  $(V_{GE}=15/0V, R_{G}=10\Omega, T_{j}=150^{\circ}C, Dynamic test circuit in Figure E)$ 

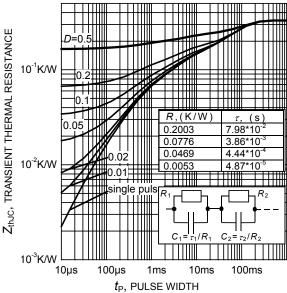
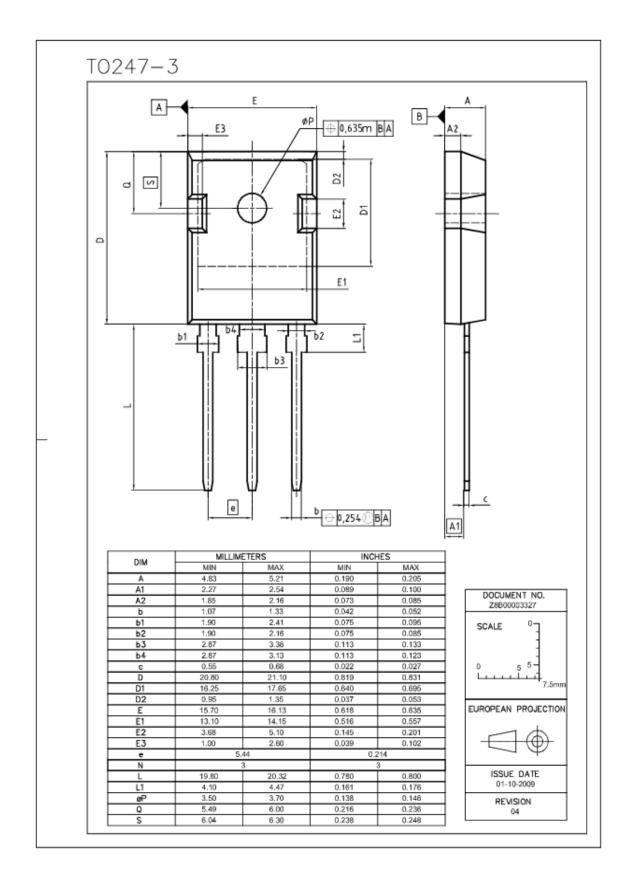
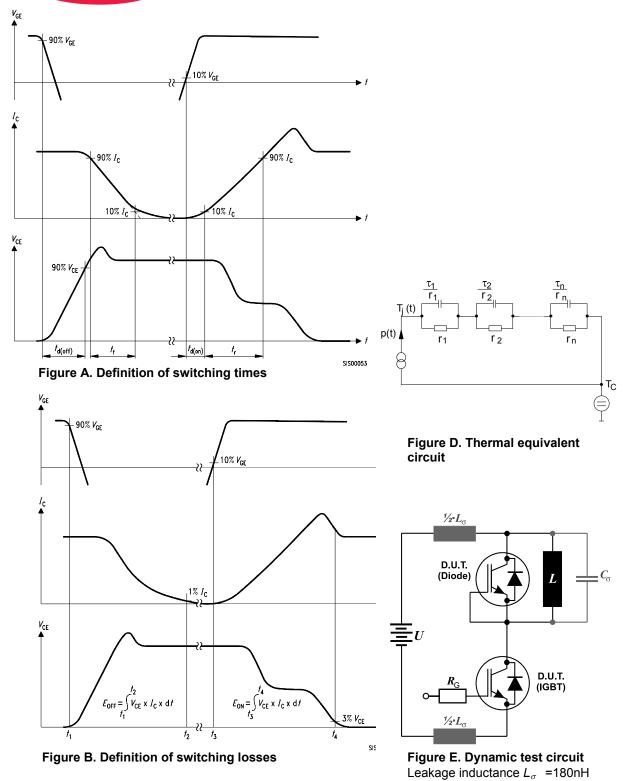


Figure 23. IGBT transient thermal resistance  $(D = t_p / T)$ 









and Stray capacity  $C_{\sigma}$  =39pF.



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